IEEE Microwave and Wireless Components Letters Tatsuo Itoh Prize

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The 2024 Microwave and Wireless Components Letters Tatsuo Itoh Prize is awarded to Mohamed H. Eissa, Gunter Fischer, Thomas Mausolf, Holger Ruecker, Andrea Malignaggi and Gerhard Kahmen for their paper entitled, "220-320-GHz J-Band 4-Way Power Amplifier in Advanced 130-nm BiCMOS Technology," IEEE Microwave and Wireless Components Letters, vol. 32, no. 11, Nov. 2022.



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No photo or bio available at time of publication.

Thomas Mausolf

No photo or bio available at time of publication.

Holger Ruecker

No photo or bio available at time of publication.

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